



**THE DATASHEET OF  
PAM2306AYPKE**



## Description

The PAM2306 is a dual step-down current-mode, DC-DC converter. At heavy load, the constant frequency PWM control provides excellent stability and transient response. To ensure the longest battery life in portable applications, the PAM2306 provides a power-saving Pulse-Skipping Modulation (PSM) mode to reduce quiescent current under light load operation.

The PAM2306 supports a range of input voltages from 2.5V to 5.5V, allowing the use of a single Li+/Li-polymer cell, multiple Alkaline/NiMH cell, USB, and other standard power sources. The dual output voltages are available for 3.3V, 2.8V, 2.5V, 1.8V, 1.5V, 1.2V or adjustable. All versions employ internal power switch and synchronous rectifier to minimize external part count and realize high efficiency. During shutdown, the input is disconnected from the output and the shutdown current is less than 0.1A. Other key features include under-voltage lockout to prevent deep battery discharge.

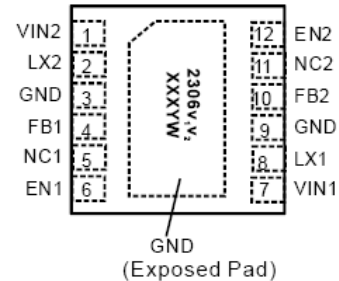
## Features

- Efficiency up to 96%
- Only 40µA (Typ. Per Channel) Quiescent Current
- Output Current: Up to 1A per Channel
- Internal Synchronous Rectifier
- 1.5MHz Switching Frequency
- Soft Start
- Under-Voltage Lockout
- Short Circuit Protection
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.017 grams (Approximate).
- Thermal Shutdown
- Small U-DFN3030-12 Package
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact@diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## Pin Assignments

(Top View)

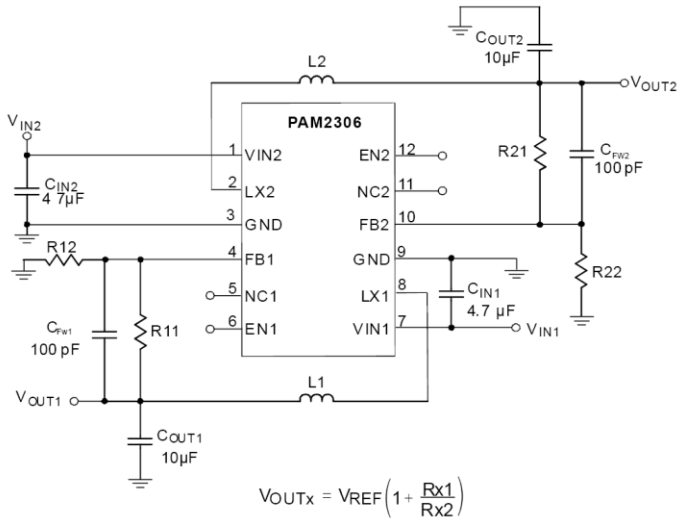


**U-DFN3030-12**

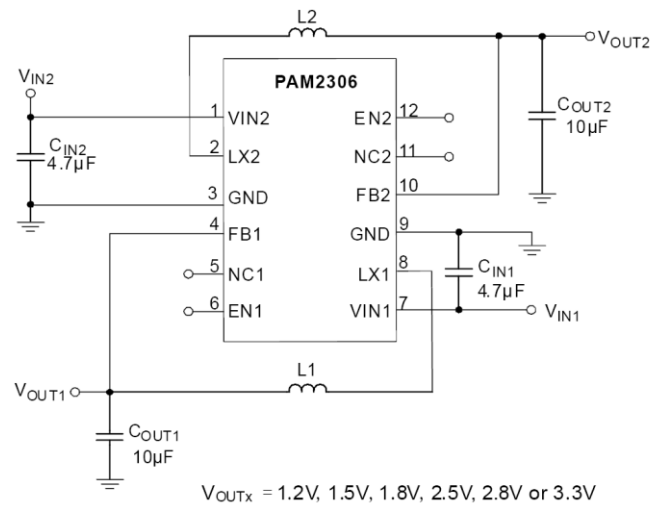
## Applications

- Cellular Phone
- Portable Electronics
- Personal Information Appliances
- Wireless and DSL Modems
- MP3 Players

**Typical Applications Circuit**



**Figure 1. Adjustable Voltage Regulator**

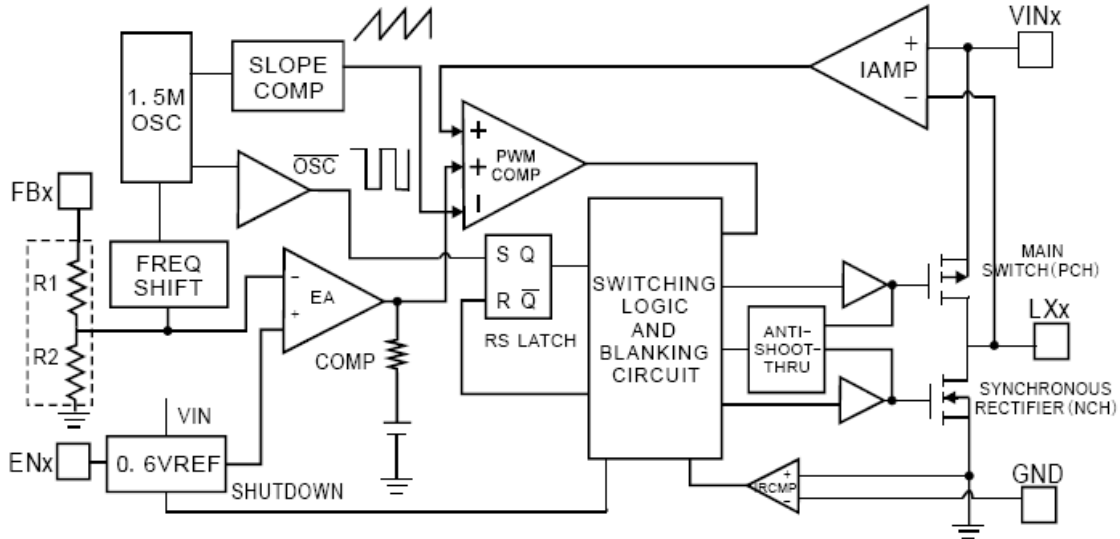


**Figure 2. Fixed Voltage Regulator**

**Pin Descriptions**

Pin Number	Pin Name U-DFN3030-12	Function
1	VIN2	Power Input of Channel 2.
2	LX2	Pin for Switching of Channel 2.
3, 9 Exposed Pad	GND	Ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.
4	FB1	Feedback of Channel 1.
5, 11	NC1, NC2	No Connection.
6	EN1	Chip Enable of Channel 1 (Active High). $V_{EN1} \leq V_{IN1}$ .
7	VIN1	Power Input of Channel 1.
8	LX1	Pin for Switching of Channel 1.
10	FB2	Feedback of Channel 2.
12	EN2	Chip Enable of Channel 2 (Active High). $V_{EN2} \leq V_{IN2}$ .

**Functional Block Diagram**



**Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

These are stress ratings only and functional operation is not implied. Exposure to absolute maximum ratings for prolonged time periods may affect device reliability. All voltages are with respect to ground.

Parameter	Rating	Unit
Input Voltage	-0.3 to +6.5	V
EN1, FB1, LX1, EN2, FB2 and LX2 Pin Voltage	-0.3 to (V <sub>IN</sub> +0.3)	V
Maximum Junction Temperature	150	°C
Storage Temperature Range	-65 to +150	°C
Soldering Temperature	260, 10s	°C

**Recommended Operating Conditions** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Parameter	Rating	Unit
Supply Voltage	2.5 to 5.5	V
Ambient Temperature Range	-40 to +85	°C
Junction Temperature Range	-40 to +125	°C

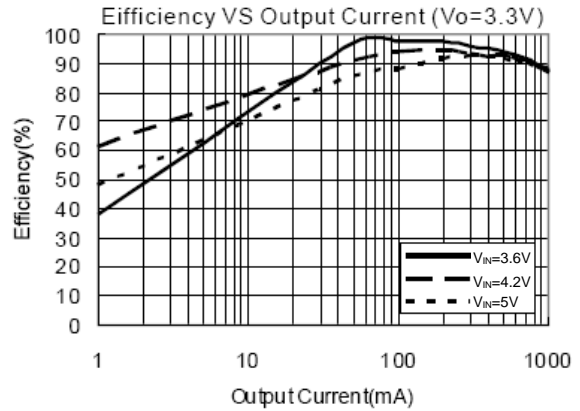
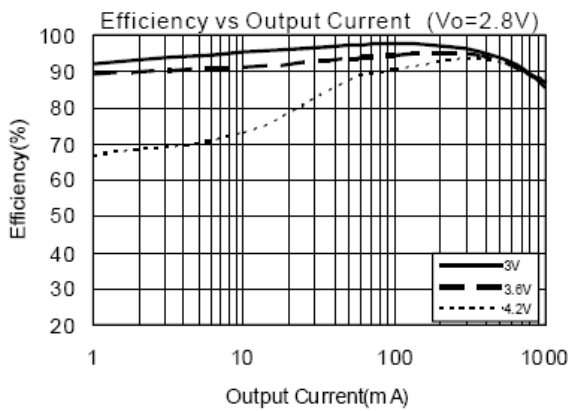
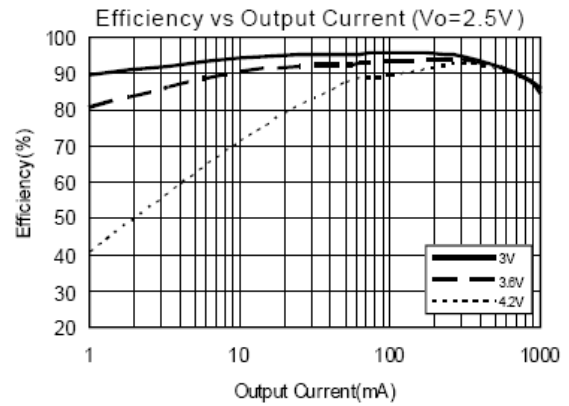
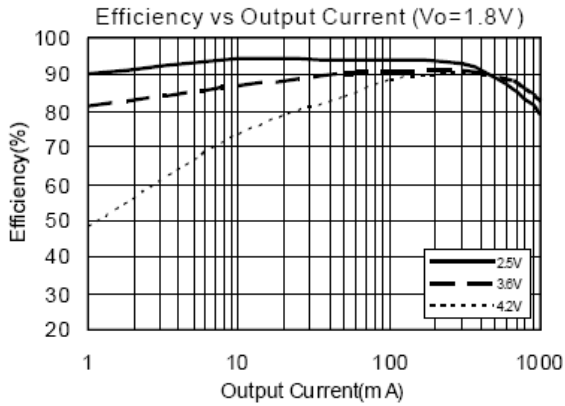
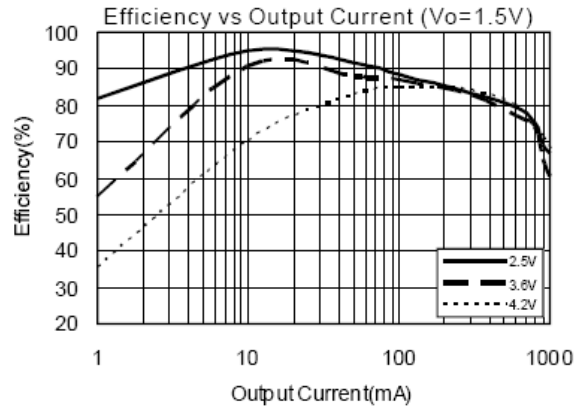
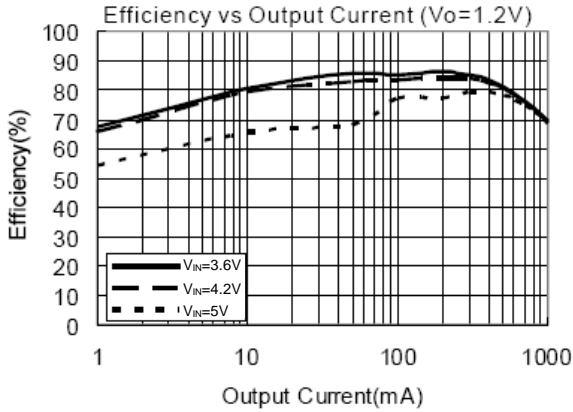
**Thermal Information**

Parameter	Symbol	Package	Maximum	Unit
Thermal Resistance (Junction to Ambient)	θ <sub>JA</sub>	U-DFN3030-12	60	°C/W
Thermal Resistance (Junction to Case)	θ <sub>JC</sub>	U-DFN3030-12	8.5	°C/W
Power Dissipation	P <sub>D</sub>	U-DFN3030-12	1.66	W

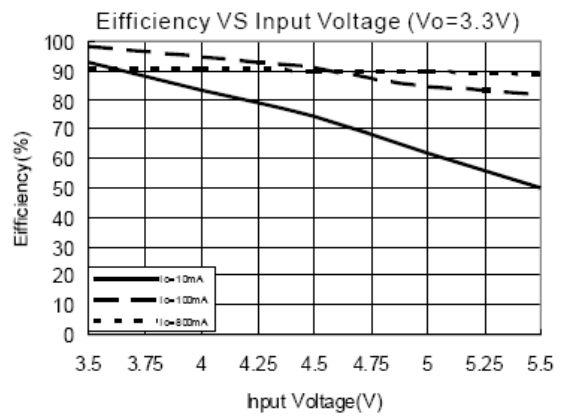
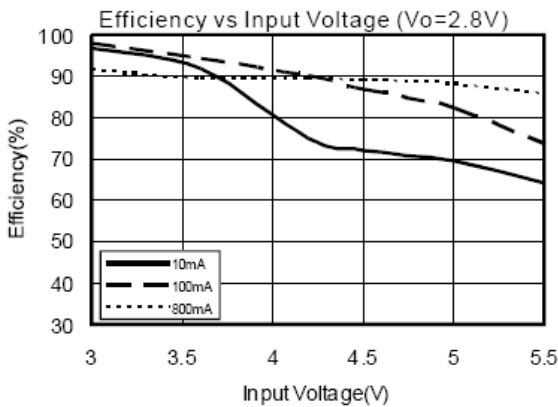
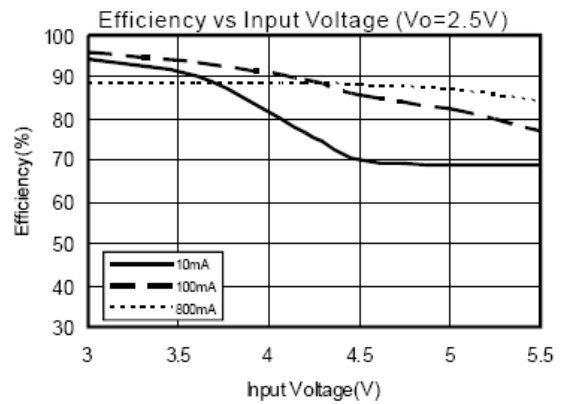
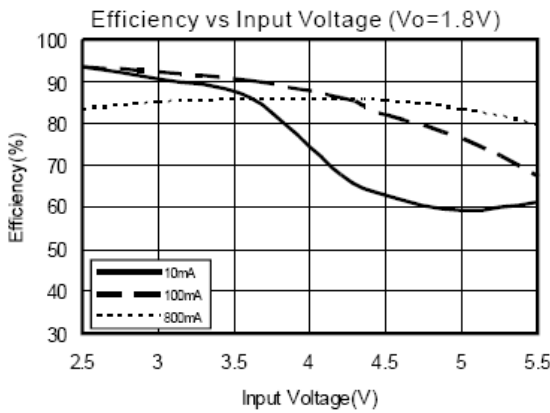
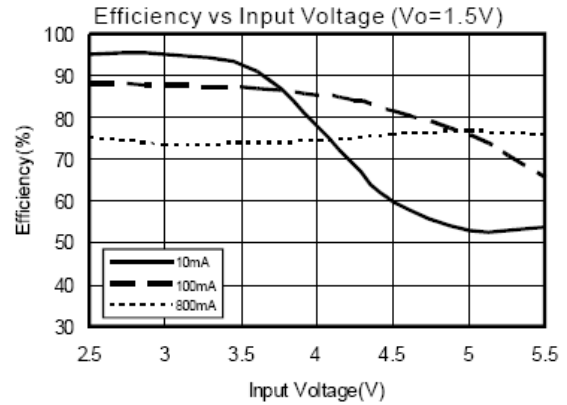
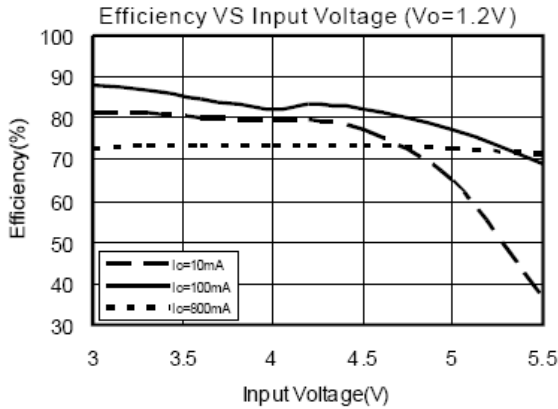
**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ ,  $V_{IN} = 3.6\text{V}$ ,  $V_O = 1.8\text{V}$ ,  $C_{IN} = 10\mu\text{F}$ ,  $C_O = 10\mu\text{F}$ ,  $L = 2.2\mu\text{H}$ , unless otherwise specified.)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit	
Input Voltage Range	$V_{IN}$	—	2.5	—	5.5	V	
Regulated Feedback Voltage	$V_{FB}$	—	0.588	0.6	0.612	V	
Reference Voltage Line Regulation	$\Delta V_{FB}$	—	—	0.3	—	%/V	
Regulated Output Voltage Accuracy	$V_O$	$I_O = 10\text{mA}$	-3	—	+3	%	
Peak Inductor Current	$I_{PK}$	$V_{IN} = 3\text{V}$ , $V_{FB} = 0.5\text{V}$ or $V_O = 90\%$	—	1.5	—	A	
Output Voltage Line Regulation	LNR	$V_{IN} = 2.5\text{V}$ to $5\text{V}$ , $I_O = 10\text{mA}$	—	0.2	0.5	%/V	
Output Voltage Load Regulation	LDR	$I_O = 1\text{mA}$ to $1\text{A}$	—	0.5	1.5	%	
Quiescent Current (Per Channel)	$I_Q$	No load	—	40	70	$\mu\text{A}$	
Shutdown Current (Per Channel)	$I_{SD}$	$V_{EN} = 0\text{V}$	—	0.1	1	$\mu\text{A}$	
Oscillator Frequency	$f_{OSC}$	$V_O = 100\%$	1.2	1.5	1.8	MHz	
		$V_{FB} = 0\text{V}$ or $V_O = 0\text{V}$	—	500	—	kHz	
Drain-Source On-State Resistance	$R_{DS(ON)}$	$I_{DS} = 100\text{mA}$	P MOSFET	—	0.3	0.45	$\Omega$
			N MOSFET	—	0.35	0.5	$\Omega$
SW Leakage Current (Per Channel)	$I_{LSW}$	—	—	$\pm 0.01$	1	$\mu\text{A}$	
High Efficiency	$\eta$	—	—	96	—	%	
EN Threshold High	$V_{EH}$	—	1.5	—	—	V	
EN Threshold Low	$V_{EL}$	—	—	—	0.3	V	
EN Leakage Current	$I_{EN}$	—	—	$\pm 0.01$	—	$\mu\text{A}$	
Over Temperature Protection	OTP	—	—	+150	—	$^\circ\text{C}$	
OTP Hysteresis	OTH	—	—	+30	—	$^\circ\text{C}$	

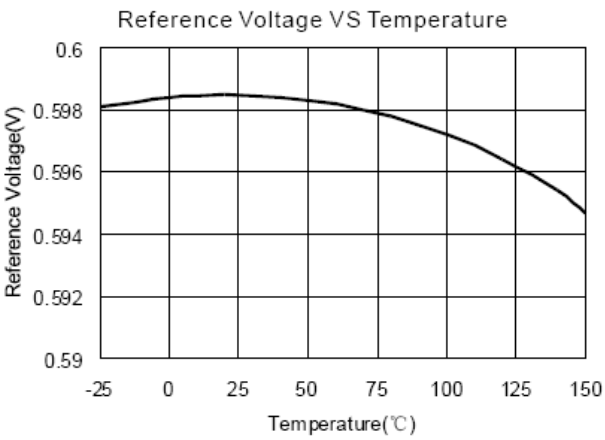
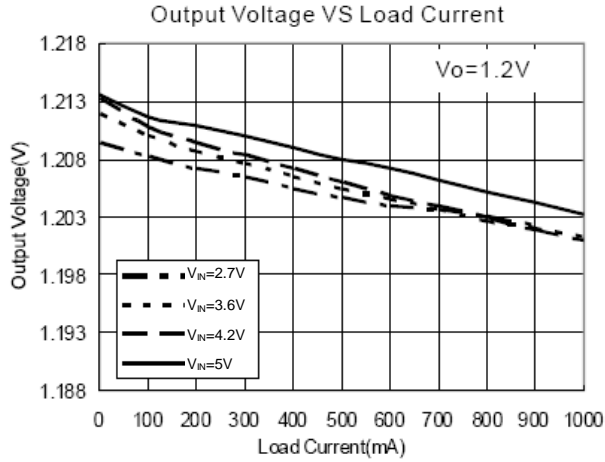
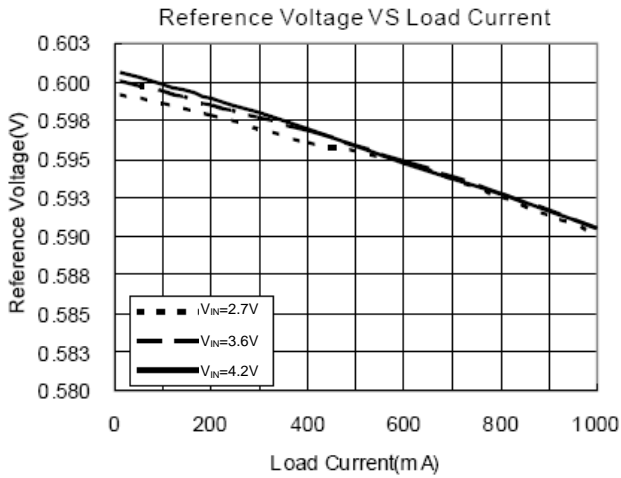
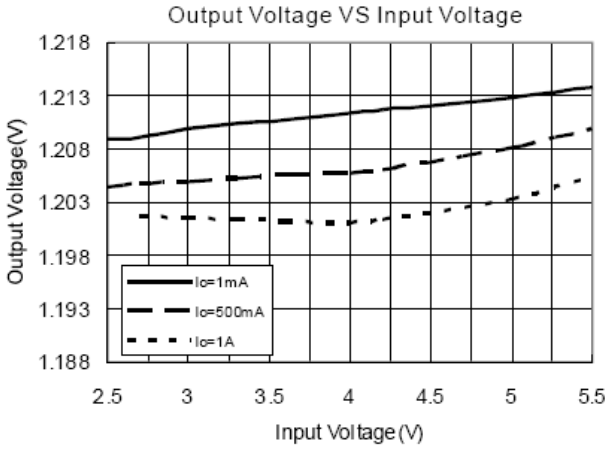
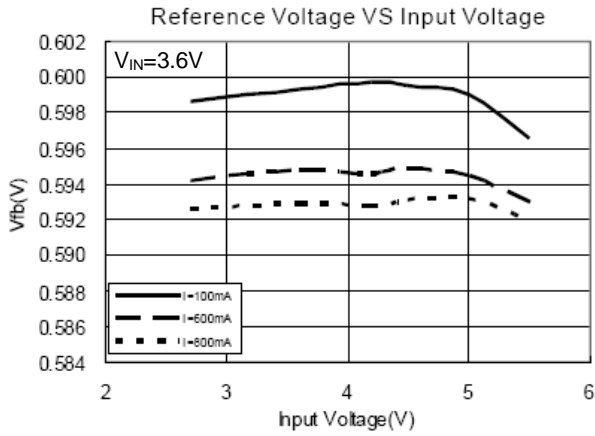
**Typical Performance Characteristics** (@ $T_A = +25^\circ\text{C}$ ,  $C_{IN} = 10\mu\text{F}$ ,  $C_O = 10\mu\text{F}$ ,  $L = 4.7\mu\text{H}$ , unless otherwise specified.)



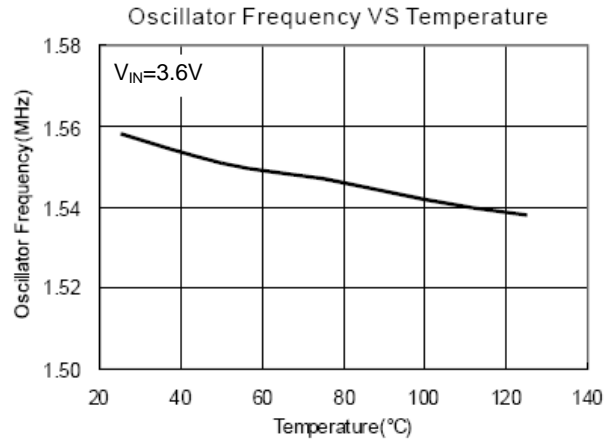
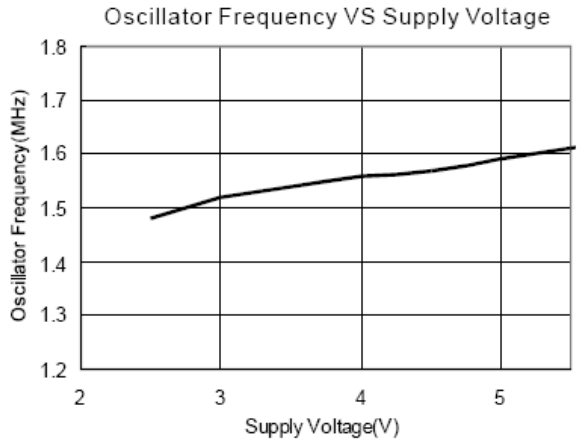
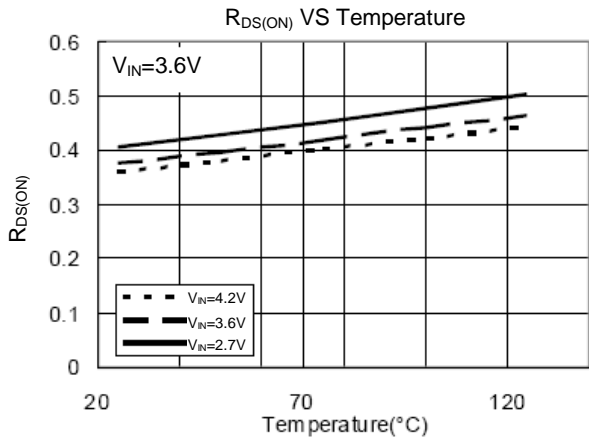
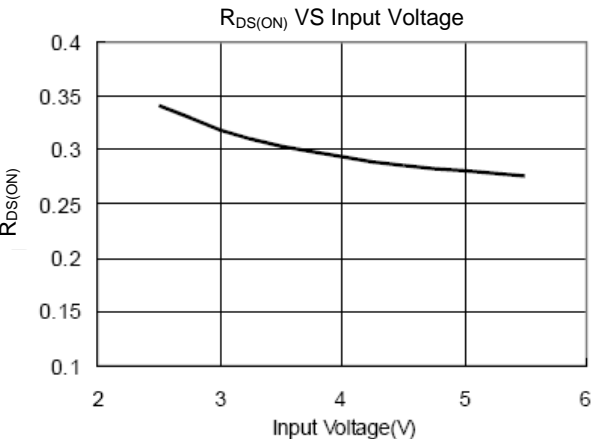
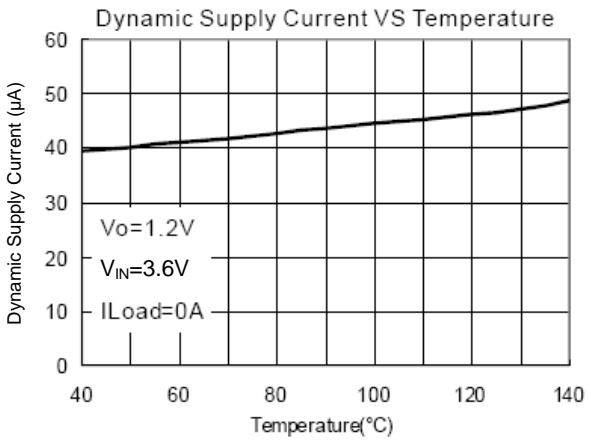
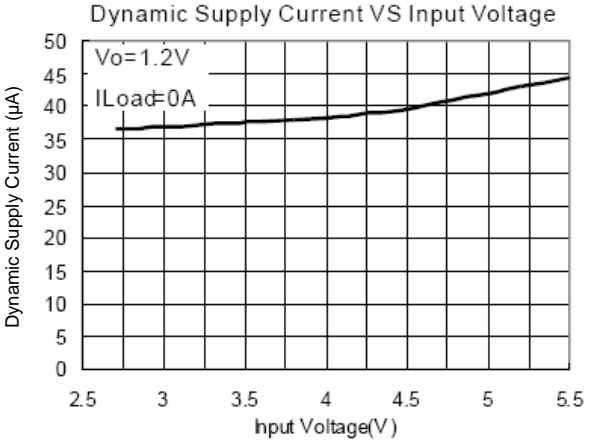
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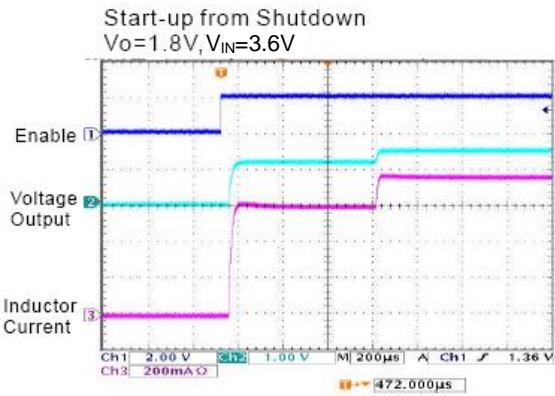
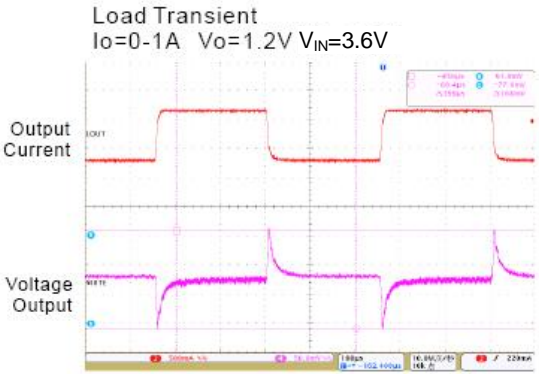
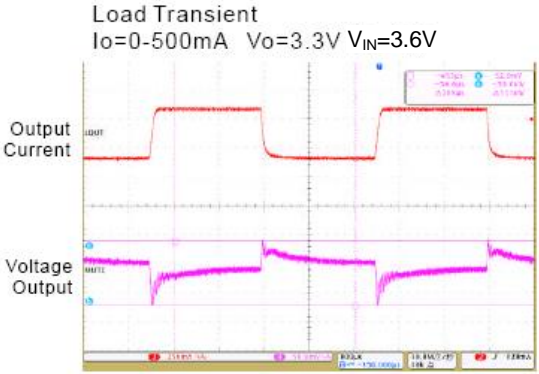
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**Typical Performance Characteristics** (continued) (@ $T_A = +25^\circ\text{C}$ ,  $C_{IN} = 10\mu\text{F}$ ,  $C_O = 10\mu\text{F}$ ,  $L = 4.7\mu\text{H}$ , unless otherwise specified.)



**Typical Performance Characteristics** (continued) (@ $T_A = +25^\circ\text{C}$ ,  $C_{IN} = 10\mu\text{F}$ ,  $C_O = 10\mu\text{F}$ ,  $L = 4.7\mu\text{H}$ , unless otherwise specified.)



## Application Information

The basic PAM2306 application circuit is shown in Page 2. External component selection is determined by the load requirement, selecting L first and then C<sub>IN</sub> and C<sub>OUT</sub>.

### Inductor Selection

For most applications, the value of the inductor will fall in the range of 1μH to 4.7μH. Its value is chosen based on the desired ripple current. Large value inductors lower ripple current and small value inductors result in higher ripple currents. Higher V<sub>IN</sub> or V<sub>OUT</sub> also increases the ripple current as shown in Equation 1. A reasonable starting point for setting ripple current is ΔI<sub>L</sub> = 400mA (40% of 1A).

$$\Delta I_L = \frac{1}{(f)(L)} V_{OUT} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right) \quad \text{Equation (1)}$$

The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. Thus, a 1.4A rated inductor should be enough for most applications (1A + 400mA). For better efficiency, choose a low DC-resistance inductor.

V <sub>O</sub>	1.2V	1.5V	1.8V	2.5V	3.3V
L	2.2 μH	2.2 μH	2.2 μH	4.7 μH	4.7μH

### C<sub>IN</sub> and C<sub>OUT</sub> Selection

In continuous mode, the source current of the top MOSFET is a square wave of duty cycle V<sub>OUT</sub>/V<sub>IN</sub>. To prevent large voltage transients, a low ESR input capacitor sized for the maximum RMS current must be used. The maximum RMS capacitor current is given by:

$$C_{IN\text{required}} I_{RMS} \cong I_{O\text{MAX}} \frac{[V_{OUT}(V_{IN} - V_{OUT})]^{1/2}}{V_{IN}}$$

This formula has a maximum at V<sub>IN</sub> = 2V<sub>OUT</sub>, where I<sub>RMS</sub> = I<sub>OUT</sub> / 2. This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Note that the capacitor manufacturer's ripple current ratings are often based on 2000 hours of life. This makes it advisable to further derate the capacitor, or choose a capacitor rated at a higher temperature than required. Consult the manufacturer if there is any question.

The selection of C<sub>OUT</sub> is driven by the required effective series resistance (ESR).

Typically, once the ESR requirement for C<sub>OUT</sub> has been met, the RMS current rating generally far exceeds the I<sub>ripple</sub> (P-P) requirement. The output ripple ΔV<sub>OUT</sub> is determined by:

$$\Delta V_{OUT} \cong \Delta I_L \left( ESR + \frac{1}{8fC_{OUT}} \right)$$

Where f = operating frequency, C<sub>OUT</sub> = output capacitance and ΔI<sub>L</sub> = ripple current in the inductor. For a fixed output voltage, the output ripple is highest at maximum input voltage since ΔI<sub>L</sub> increases with input voltage.

### Using Ceramic Input and Output Capacitors

Higher values, lower cost ceramic capacitors are now becoming available in smaller case sizes. Their high ripple current, high voltage rating and low ESR make them ideal for switching regulator applications. Using ceramic capacitors can achieve very low output ripple and small circuit size.

When choosing the input and output ceramic capacitors, choose the X5R or X7R dielectric formulations. These dielectrics have the best temperature and voltage characteristics of all the ceramics for a given value and size.

### Thermal Consideration

Thermal protection limits power dissipation in the PAM2306. When the junction temperature exceeds +150°C, the OTP (Over Temperature Protection) starts the thermal shutdown and turns the pass transistor off. The pass transistor resumes operation after the junction temperature drops below +120°C.

For continuous operation, the junction temperature should maintain below +125°C.

The power dissipation is defined as:

$$P_D = I_O^2 \frac{V_O R_{DS(ON)H} + (V_{IN} - V_O) R_{DS(ON)L}}{V_{IN}} + (t_{sw} F_{slo} + I_Q) V_{IN}$$

I<sub>Q</sub> is the step-down converter quiescent current. The term t<sub>sw</sub> is used to estimate the full load step-down converter switching losses.

## Application Information (continued)

### Thermal Consideration (continued)

For the condition where the step-down converter is in dropout at 100% duty cycle, the total device dissipation reduces to:

$$P_D = I_o^2 R_{DS(ON)H} + I_Q V_{IN}$$

Since  $R_{DS(ON)}$ , quiescent current, and switching losses all vary with input voltage, the total losses should be investigated over the complete input voltage range. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surrounding airflow and temperature difference between junction and ambient. The maximum power dissipation can be calculated by the following formula:

$$P_D = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$

Where  $T_{J(MAX)}$  is the maximum allowable junction temperature +125°C.  $T_A$  is the ambient temperature and  $\theta_{JA}$  is the thermal resistance from the junction to the ambient. Based on the standard JEDEC for a two layers thermal test board, the thermal resistance  $\theta_{JA}$  of WDFN3X3 is 60°C/W. The maximum power dissipation at  $T_A = +25^\circ\text{C}$  can be calculated by following formula:

$$P_D = (125^\circ\text{C} - 25^\circ\text{C})/60^\circ\text{C/W} = 1.66\text{W}$$

### Setting the Output Voltage

The internal reference is 0.6V (Typical). The output voltage is calculated as below:

$$V_O = 0.6 \times \left( 1 + \frac{R_1}{R_2} \right)$$

The output voltage is given by Table 1.

$V_o$	R1	R2
1.2V	100k	100k
1.5V	150k	100k
1.8V	200k	100k
2.5V	380k	120k
3.3V	540k	120k

Table 1: Resistor Selection for Output Voltage Setting

### 100% Duty Cycle Operation

As the input voltage approaches the output voltage, the converter turns the P-Channel transistor continuously on. In this mode the output voltage is equal to the input voltage minus the voltage drop across the P-Channel transistor:

$$V_{OUT} = V_{IN} - I_{LOAD} (R_{DS(ON)} + R_L)$$

Where  $R_{DS(ON)}$  = P-Channel switch ON Resistance,  $I_{LOAD}$  = Output Current,  $R_L$  = Inductor DC Resistance.

### UVLO and Soft-Start

The reference and the circuit remain reset until the  $V_{IN}$  crosses its UVLO threshold.

The PAM2306 has an internal soft-start circuit that limits the in-rush current during start-up. This prevents possible voltage drops of the input voltage and eliminates the output voltage overshoot. The soft-start acts as a digital circuit to increase the switch current in several steps to the P-Channel current limit (1500mA).

### Short Circuit Protection

The switch peak current is limited cycle-by-cycle to a typical value of 1500mA. In the event of an output voltage short circuit, the device operates with a frequency of 400kHz and minimum duty cycle, therefore the average input current is typically 200mA.

### Thermal Shutdown

When the die temperature exceeds +150°C, a reset occurs and the reset remains until the temperature decrease to +120°C, at which time the circuit can be restarted.

**Application Information** (continued)

**PCB Layout Check List**

When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the PAM2306. These items are also illustrated graphically in Figure 3. Check the following in your layout:

1. The power traces, consisting of the GND trace, the SW trace and the  $V_{IN}$  trace should be kept short, direct and wide.
2. Does the FB pin connect directly to the feedback resistors? The resistive divider R1/R2 must be connected between the (+) plate of  $C_{OUT}$  and ground.
3. Does the (+) plate of  $C_{IN}$  connect to  $V_{IN}$  as closely as possible? This capacitor provides the AC current to the internal power MOSFETs.
4. Keep the switching node, SW, away from the sensitive FB node.
5. Keep the (-) plates of  $C_{IN}$  and  $C_{OUT}$  as close as possible.

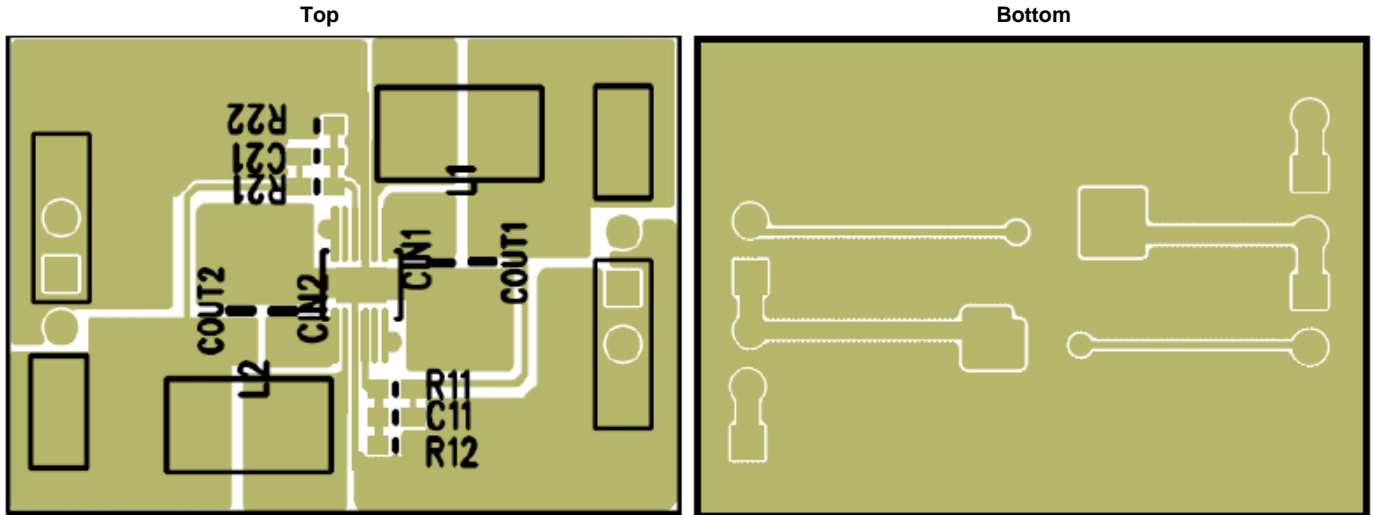
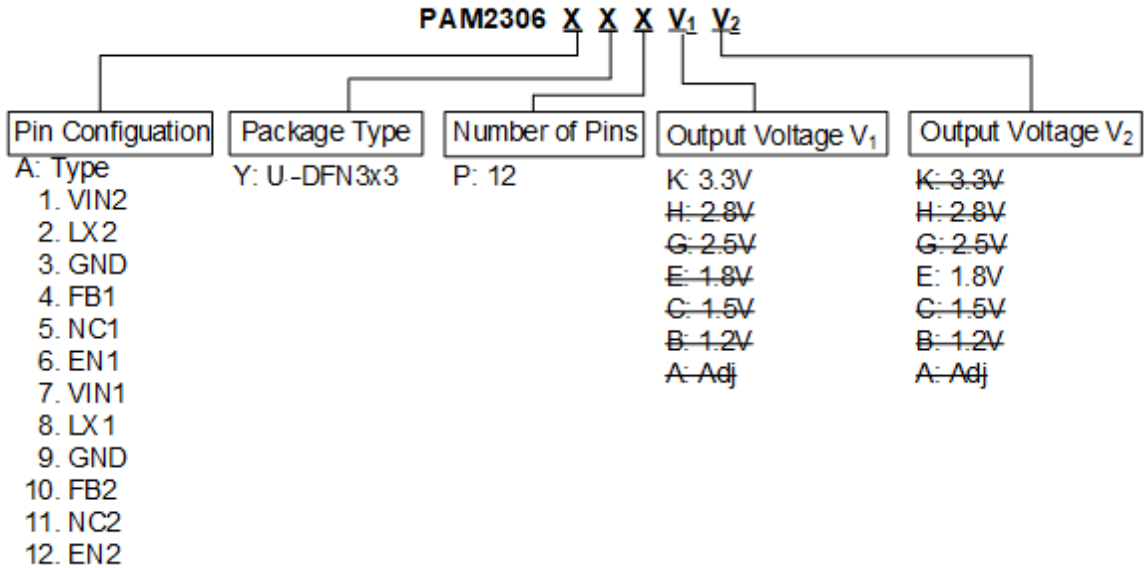


Figure 3. PAM2306 Suggested Layout

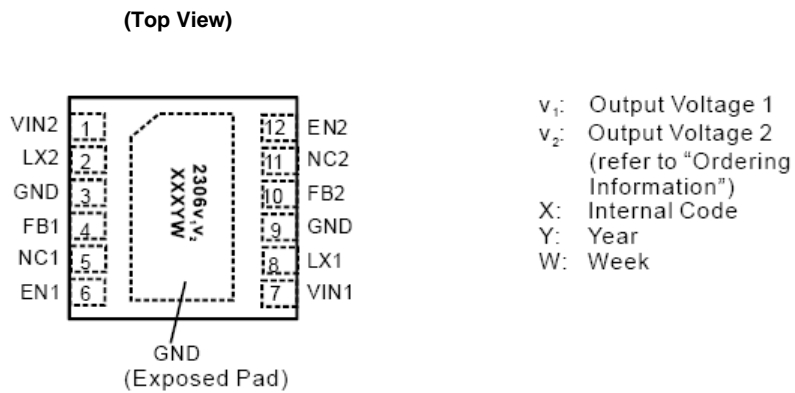
**Ordering Information**



Part Number	Marking	Package Type	Packaging
PAM2306AYPV <sub>1</sub> V <sub>2</sub> (Note 4)	2306v <sub>1</sub> v <sub>2</sub> XXX <sub>1</sub> YW	U-DFN3030-12	3000 Units/ Tape & Reel

Note: 4. PAM2306AYPKE is Active. All other versions are NRND or EOL. For recommended alternatives to NRND/EOL devices, [Contact Us](#).

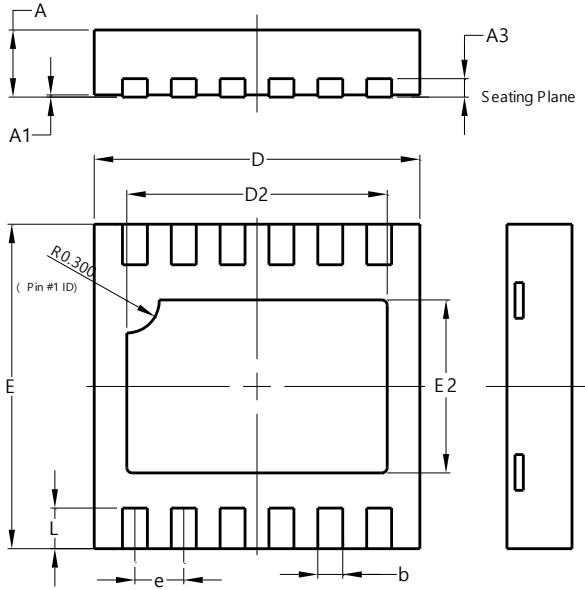
**Marking Information**



**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**U-DFN3030-12**

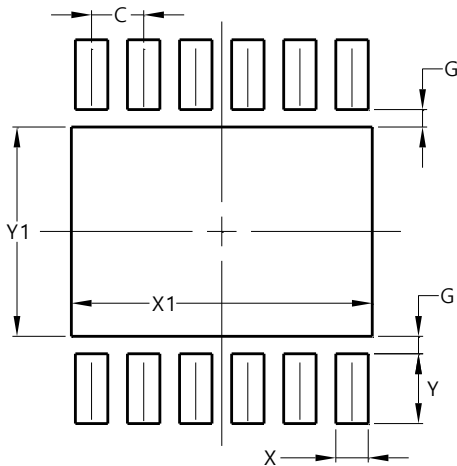


U-DFN3030-12			
Dim	Min	Max	Typ
A	0.57	0.63	0.60
A1	0	0.05	0.02
A3	-	-	0.15
b	0.18	0.28	0.23
D	2.90	3.10	3.00
D2	2.30	2.50	2.40
e	-	-	0.45
E	2.90	3.10	3.00
E2	1.50	1.70	1.60
L	0.25	0.55	0.40
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**U-DFN3030-12**



Dimensions	Value (in mm)
C	0.45
G	0.15
X	0.28
X1	2.60
Y	0.60
Y1	1.80

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